

May 2026 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. [The June Report SEAJ's Web site update](#) is scheduled on **21st July** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **May 2026 Billings of ¥526,352 million**

Tokyo Japan, [June 19th, 2026](#) JAPAN-based manufacturers of semiconductor equipment posted **¥526,352 million** in billings in [May 2026](#)(three-month average basis) published today by SEAJ.

The billings figure is **3.2 percent up** the final April 2026 level of ¥510,155 million and **17.9 percent up** the [2025 May](#) billings level of ¥446,291 million.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
December 2025	423,487	0.7%	-4.5%
January 2026	427,508	0.9%	2.6%
February 2026	423,103	-1.0%	2.7%
March 2026	480,182	13.5%	11.1%
April 2026(final)	510,155	6.2%	14.1%
May 2026(prelim)	526,352	3.2%	17.9%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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